



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/038,264 Confirmation No. 8328
Applicant : Seungbae Park et al.
Filed : January 3, 2002
TC/A.U. : 3879
Examiner : Ernesto Garcia

Docket No. : EN999048D
Title : SOLDER INTERCONNECTION TECHNIQUES
Customer No. : 41245

AMENDMENT AFTER FINAL REJECTION
IN ACCORDANCE WITH 37 C.F.R. §1.116

Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

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S I R:

In response to the Office Action of January 2, 2004,
please amend the above-identified patent application as
follows:

Amendments to the Specification begin on page 2 of this
paper.

Amendments to the Drawings begin on page 3 of this paper
and include both an attached replacement sheet and an
annotated sheet showing changes.

Amendments to the Claims are reflected in the listing of
claims which begins on page 4 of this paper.

Remarks/Arguments begin on page 7 of this paper.

An **Appendix** including amended drawing figures is attached
following page 10 of this paper.

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